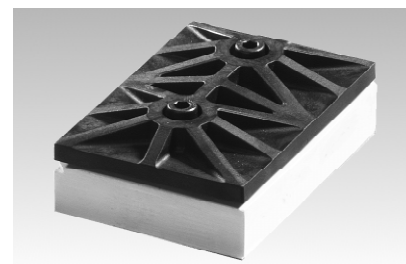


SKiiP 31 NAB 12

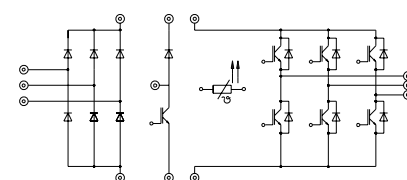
Absolute Maximum Ratings		
Symbol	Conditions ¹⁾	Units
Inverter	(Chopper see SKiiP 22 NAB 12)	
V _{CES}		1200 V
V _{GES}		± 20 V
I _C	T _{heatsink} = 25 / 80 °C	45 / 30 A
I _{CM}	t _p < 1 ms; T _{heatsink} = 25 / 80 °C	90 / 60 A
I _F = -I _C	T _{heatsink} = 25 / 80 °C	38 / 26 A
I _{FM} = -I _{CM}	t _p < 1 ms; T _{heatsink} = 25 / 80 °C	76 / 52 A
Bridge Rectifier		
V _{RRM}		1500 V
I _D	T _{heatsink} = 80 °C	35 A
I _{FSM}	t _p = 10 ms; sin. 180°, T _j = 25 °C	700 A
I ² t	t _p = 10 ms; sin. 180°, T _j = 25 °C	2400 A ² s
T _j		- 40 ... + 150 °C
T _{stg}		- 40 ... + 125 °C
V _{isol}	AC, 1 min.	2500 V

MiniSKiiP 3
SEMIKRON integrated intelligent Power
SKiiP 31 NAB 12
3-phase bridge rectifier +
braking chopper +
3-phase bridge inverter

Case M3



Characteristics			min.	typ.	max.	Units
Symbol	Conditions ¹⁾					
IGBT - Inverter						
V _{CESat}	I _C = 30 A T _j = 25 (125) °C		-	2,5(3,1)	3,0(3,7)	V
t _{d(on)}	V _{CC} = 600 V; V _{GE} = ± 15 V		-	55	110	ns
t _r		I _C = 30 A; T _j = 125 °C	-	55	110	ns
t _{d(off)}	R _{gon} = R _{goff} = 39 Ω inductive load		-	400	600	ns
t _f			-	45	90	ns
E _{on} + E _{off}			-	7,8	-	mJ
C _{ies}	V _{CE} = 25 V; V _{GE} = 0 V, 1 MHz		-	2,0	-	nF
R _{thjh}	per IGBT		-	-	0,7	K/W
IGBT - Chopper *						
V _{CESat}	I _C = 15 A T _j = 25 (125) °C		-	2,5(3,1)	3,0(3,7)	V
t _{d(on)}	V _{CC} = 600 V; V _{GE} = ± 15 V		-	55	110	ns
t _r		I _C = 15 A; T _j = 125 °C	-	45	90	ns
t _{d(off)}	R _{gon} = R _{goff} = 82 Ω inductive load		-	400	600	ns
t _f			-	70	100	ns
E _{on} + E _{off}			-	4,0	-	mJ
C _{ies}	V _{CE} = 25 V; V _{GE} = 0 V, 1 MHz		-	1,0	-	nF
R _{thjh}	per IGBT		-	-	1,4	K/W
Diode ²⁾ - Inverter (Diode ²⁾ - Chopper see SKiiP 22 NAB 12)						
V _F = V _{EC}	I _F = 25 A T _j = 25 (125) °C		-	2,0(1,8)	2,5(2,3)	V
V _{TO}	T _j = 125 °C		-	1,0	1,2	V
r _T	T _j = 125 °C		-	32	44	mΩ
I _{RRM}	I _F = 25 A, V _R = - 600 V		-	25	-	A
Q _{rr}		di _F /dt = - 500 A/μs	-	4,5	-	μC
E _{off}	V _{GE} = 0 V, T _j = 125 °C		-	1,0	-	mJ
R _{thjh}	per diode		-	-	1,2	K/W
Diode - Rectifier						
V _F	I _F = 35 A, T _j = 25 °C		-	1,2	-	V
R _{thjh}	per diode		-	-	1,6	K/W
Temperature Sensor						
R _{TS}	T = 25 / 100 °C			1000 / 1670		Ω
Mechanical Data						
M ₁	case to heatsink, SI Units		2	-	2,5	Nm
Case	mechanical outline see page B 16 - 9			M3		



UL recognized file no. E63532

- specification of temperature sensor see part A
- common characteristics B 16 - 4

Options

- also available with powerful chopper. For characteristics please refer to Inverter IGBT

- 1) T_{heatsink} = 25 °C, unless otherwise specified
 2) CAL = Controlled Axial Lifetime Technology (soft and fast recovery)

* For diagrams of the Chopper IGBT please refer to SKiiP 22 NAB 12

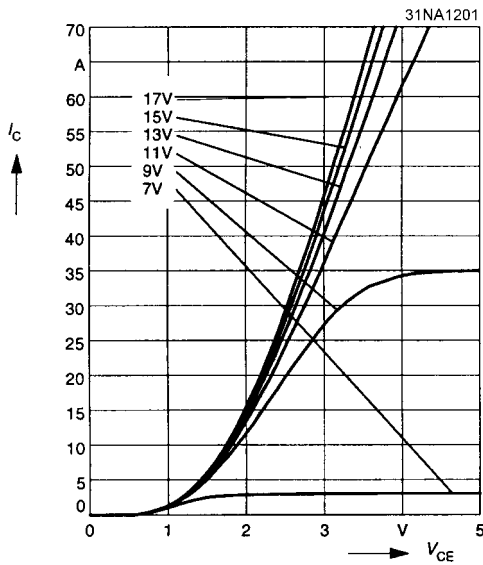


Fig. 1 Typ. output characteristic, $t_p = 80 \mu s$; $25^\circ C$

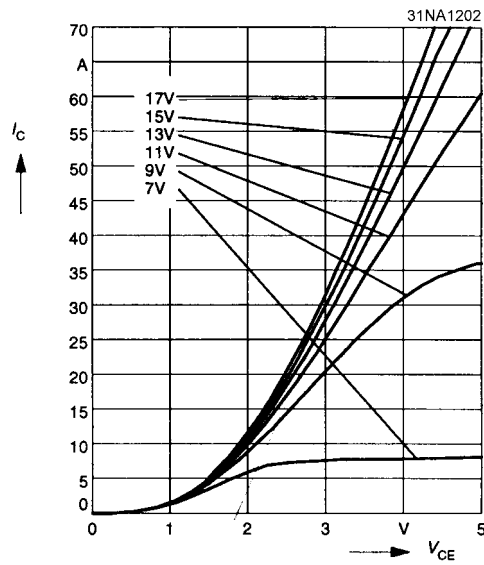


Fig. 2 Typ. output characteristic, $t_p = 80 \mu s$; $125^\circ C$

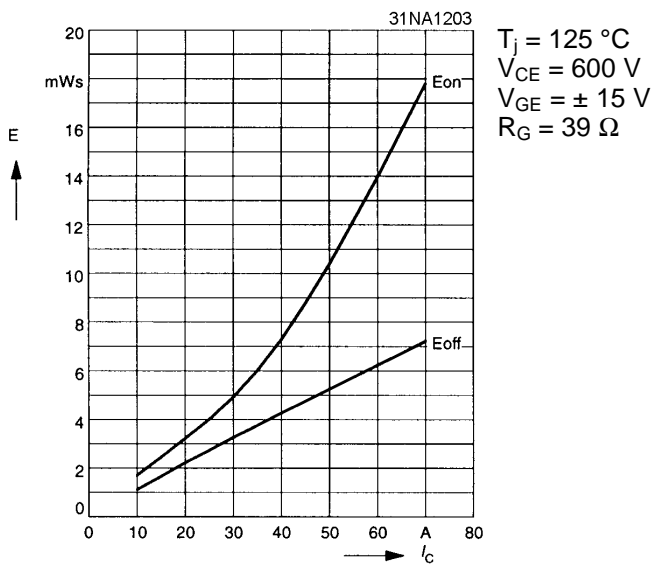


Fig. 3 Turn-on /-off energy = $f(I_c)$

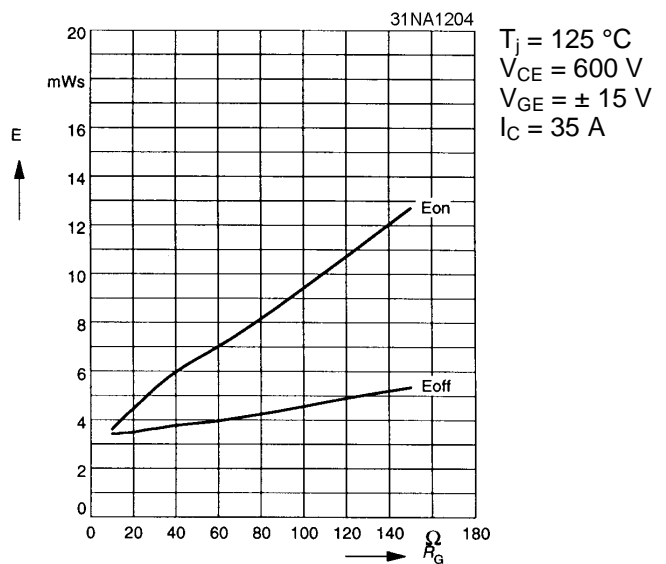


Fig. 4 Turn-on /-off energy = $f(R_G)$

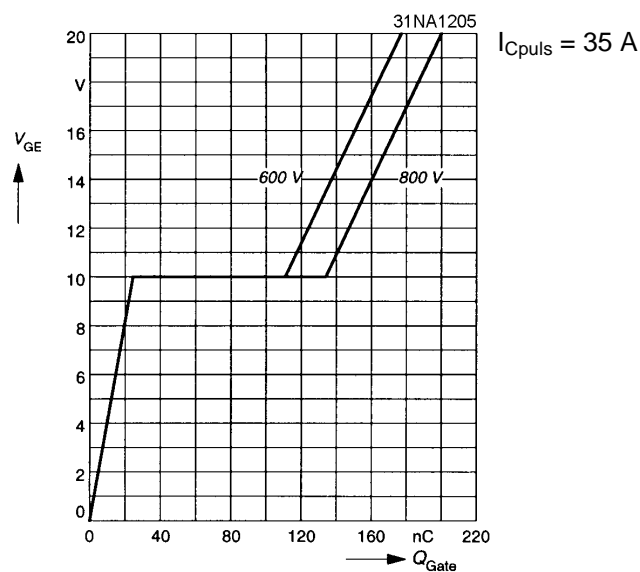


Fig. 5 Typ. gate charge characteristic

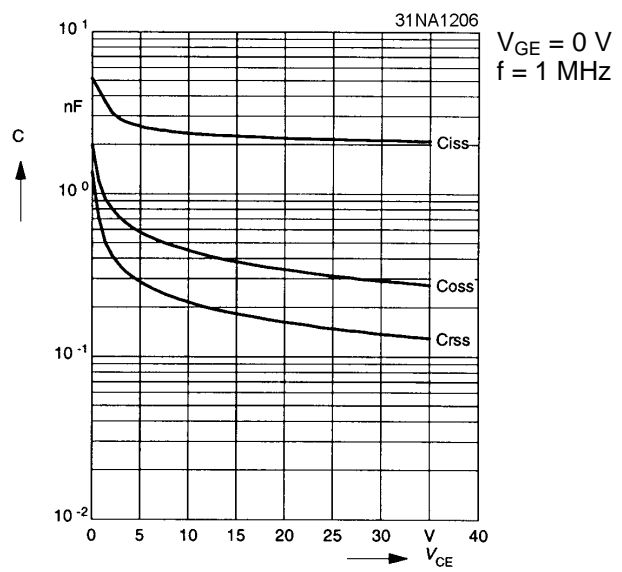


Fig. 6 Typ. capacitances vs. V_{CE}

MiniSKiiP 1200 V

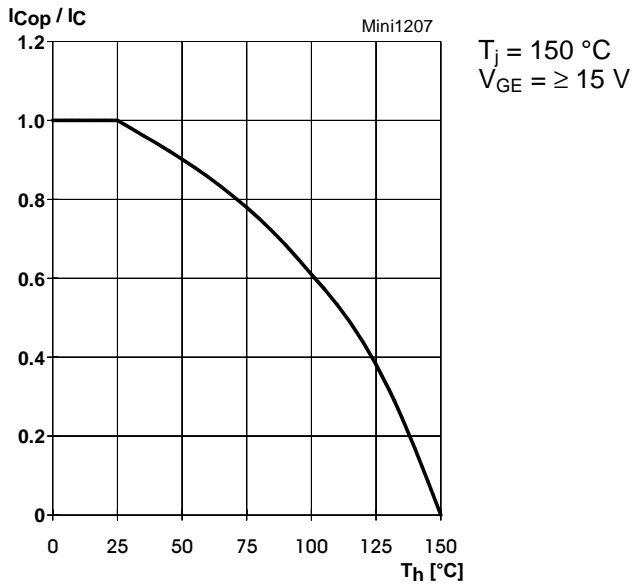


Fig. 7 Rated current of the IGBT $I_{COp} / I_C = f(T_h)$

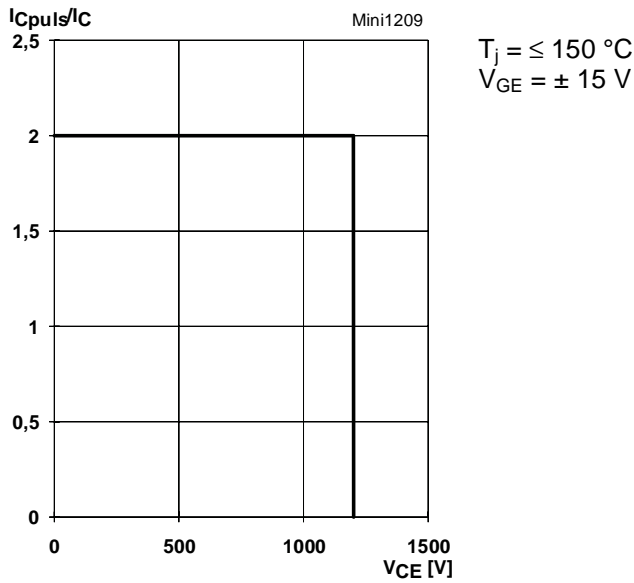


Fig. 9 Turn-off safe operating area (RBSOA) of the IGBT

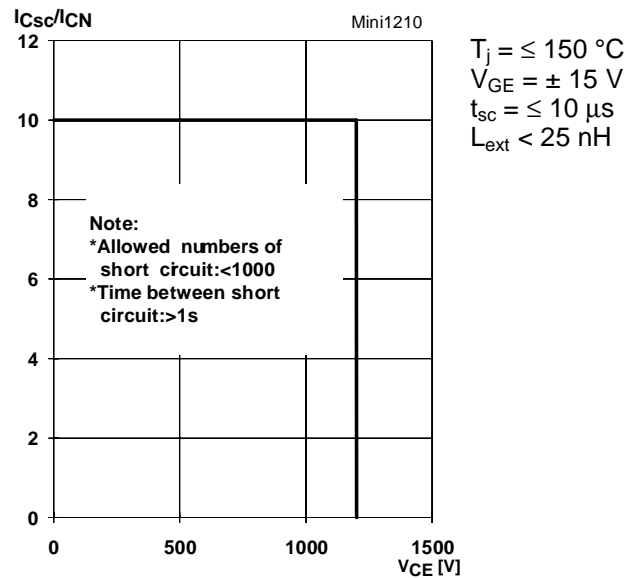


Fig. 10 Safe operating area at short circuit of the IGBT

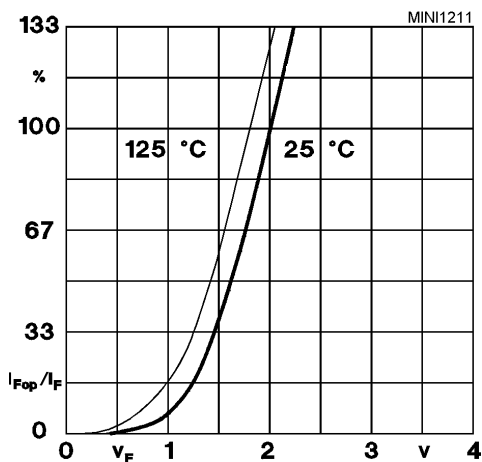


Fig. 11 Typ. freewheeling diode forward characteristic

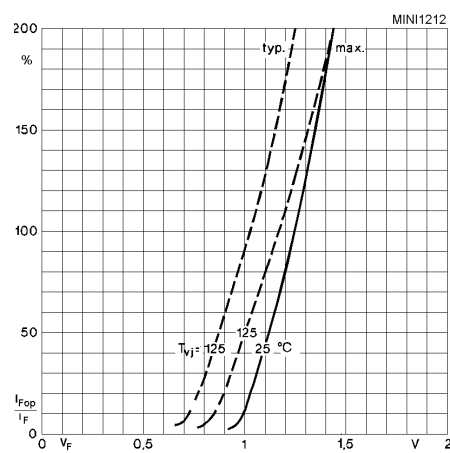


Fig. 12 Forward characteristic of the input bridge diode

MiniSKiiP 3

SKiiP 30 NAB 06
 SKiiP 31 NAB 06
 SKiiP 32 NAB 06
 SKiiP 30 NAB 12
 SKiiP 31 NAB 12
 SKiiP 32 NAB 12

Circuit
 Case M3
 Layout and connections for the
 customer's printed circuit board

